

DOCKET NUMBER: 217636US3/rm



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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF : Shigeo KOUZUKI, et al.

SERIAL NUMBER: 10/020,928 : GROUP: 2814

FILED: December 19, 2001 : EXAMINER:

FOR: SEMICONDUCTOR DEVICE AND PACKAGE THEREOF

LETTER


Assistant Commissioner for Patents
Washington, D.C. 20231

Sir:

On March 20, 2002, we filed an Information Disclosure Statement citing reference JP 2000-114445. Submitted herewith is the Statement of Relevancy of the same for Examiner's consideration.

Respectfully submitted,

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STATEMENT OF RELEVANCY

Reference JP 2000-114445:

This reference discloses a Cu strap which decreases resistance and inductance of a MOS device. A semiconductor package which has a copper plate coupled to a major part of source metal, and a beam part. Indurative conductive material is sandwiched between the copper plate and source metal.